



Click [here](#) for the 3D model.

### Dimensions

Chip Size	1206
L	3.07mm +/-0.38mm (0.121 in +/-0.015 in)
W	1.52mm +/-0.38mm (0.06 in +/-0.015 in)
T	1.6mm MAX (0.063 in MAX)
B	0.51mm +/-0.25mm (0.02 in +/-0.01 in)

### Packaging Specifications

Packaging	Bulk, Bag
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### General Information

Series	GR900 SMD Space
Style	SMD Chip
RoHS	No
Prop 65	<b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> .
SCIP Number	2a1e1a41-ed35-45dd-8d0d-907fc06efdab
Termination	Lead (SnPb)
Failure Rate	N/A
Testing and Reliability	GR900 CSAM A
AEC-Q200	No
Shelf Life	78 Weeks
MSL	1

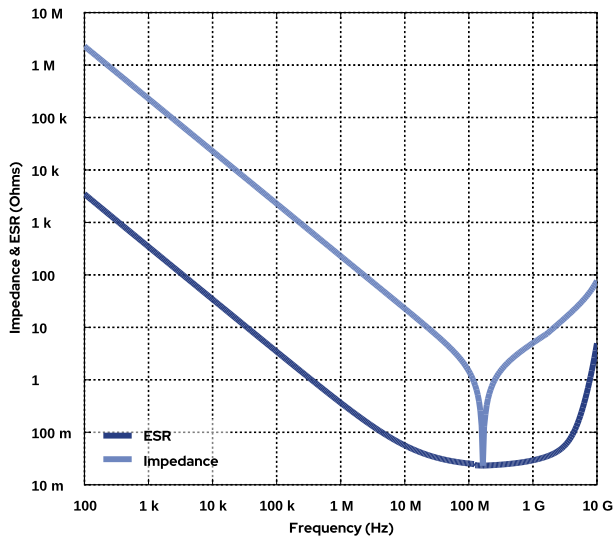
### Specifications

Capacitance	680 pF
Capacitance Tolerance	1%
Voltage DC	100 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BP

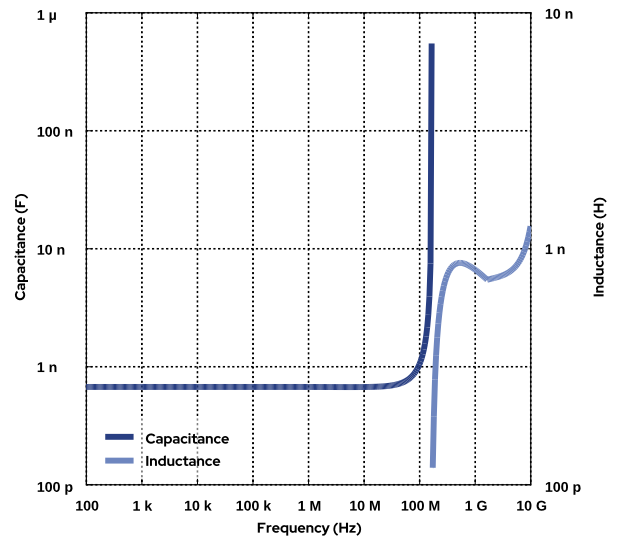
## Simulations

For the complete simulation environment please visit [K-SIM](#).

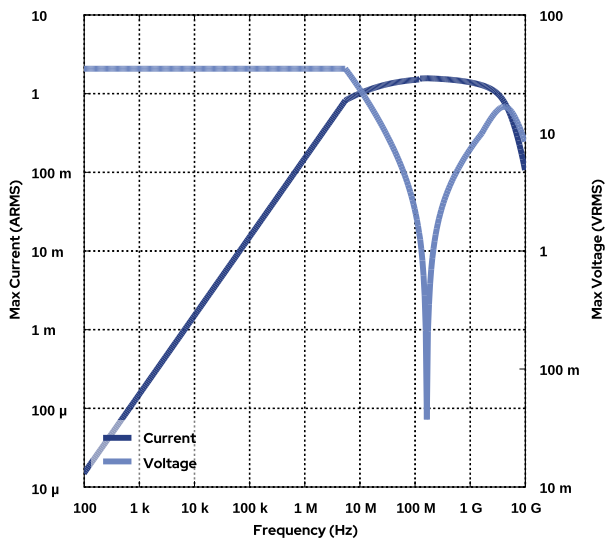
**Impedance and ESR**



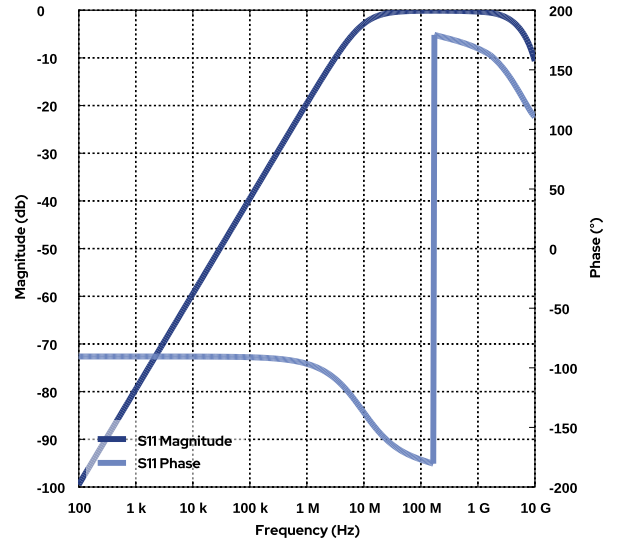
**Capacitance and Inductance**

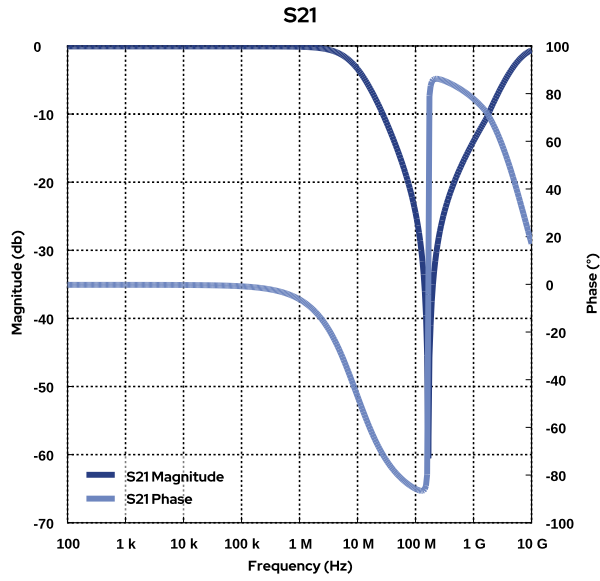


**Current and Voltage**



**S11**





**These are simulations.**

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.